

Discription

The HRSB6.8CMGJT2N 8K/R protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



SOD-923

Features

- ★ Ultra Low Capacitance 15 pF
- ★ Low Clamping Voltage
- ★ Small Body Outline Dimensions: 0.031" x 0.024" (0.80 mm x 0.60 mm)
- ★ Low Body Height: 0.015" (0.37 mm)
- ★ Stand-off Voltage: 5 V
- ★ Low Leakage
- ★ Response Time is Typically < 1.0 ns
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ This is a Pb-Free Device

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Circuit Diagram

Orderingin formation

| Product ID | Pack | Qty(PCS) |
|---------------------|---------|----------|
| HRSB6.8CMGJT2N 8K/R | SOD-923 | 8000 |

Absolute Ratings(Tamb = 25°C)

| Symbol | Parameter | Value | Units |
|------------------|---|-------------|-------|
| P _{PP} | Peak Pulse Power ($t_p = 8/20 \mu s$) | 80 | W |
| TL | Maximum lead temperature for soldering during 10s | 260 | °C |
| T _{stg} | Storage Temperature Range | -55 to +155 | °C |
| T _{op} | Operating Temperature Range | -40 to +125 | °C |
| Tj | Maximum junction temperature | 150 | °C |
| | IEC61000-4-2 (ESD) air discharg contact discharg | | KV |

Stresses exceeding Maximum Ratings may damage the device. Maximum Rating are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 = 1.0*0.75*0.62 in.

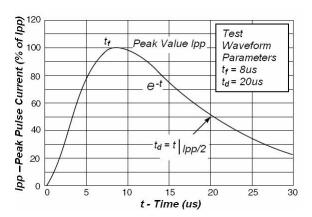


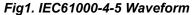
Electrical Characteristics (T_A = 25°C unless otherwise noted)

| Device | V _{RWM} (V) | Ι _R (μΑ) @ V _{RWM} | V _{BR} (V) @ I _T (Note 2) | I _T | C (pF) | V _C (V) @ I _{PP} = 5 A | lpp (A) | Ppk (W) (8*20 µs) |
|---------------------|-------------------------|---|--|----------------|--------|---|------------|-------------------------|
| Devide | Max | Max | Min | mA | Тур | Max | Max | Max |
| HRSB6.8CMGJT2N 8K/R | 5.0 | 0.1 | 5.6 | 1.0 | 15 | 8.5 | 8 | 80 |

^{2.} V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.

Typical Characteristics





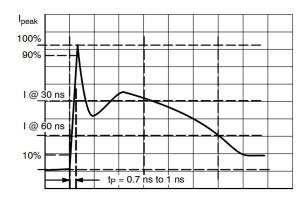
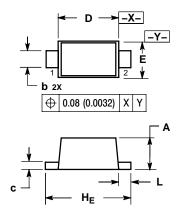


Fig2.IEC61000-4-2 Waveform



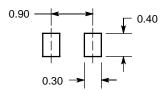
SOD-923 Outline And Dimensions



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 0.34 | 0.37 | 0.40 | 0.013 | 0.015 | 0.016 |
| b | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| С | 0.07 | 0.12 | 0.17 | 0.003 | 0.005 | 0.007 |
| D | 0.75 | 0.80 | 0.85 | 0.030 | 0.031 | 0.033 |
| E | 0.55 | 0.60 | 0.65 | 0.022 | 0.024 | 0.026 |
| HE | 0.95 | 1.00 | 1.05 | 0.037 | 0.039 | 0.041 |
| L | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 |

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

HRSB6.8CMGJT2N 8K/R ESD PROTECTION DIODE

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